

Introducing Sherlock Automated Design Analysis™ 3.0 with 3D Capability

The Revolution

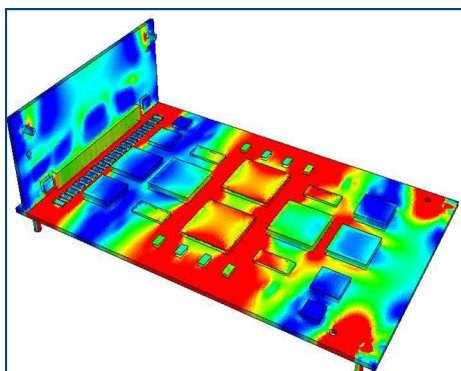
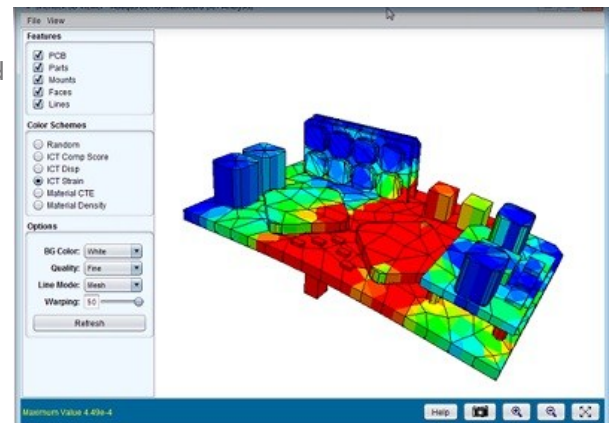
Sherlock Automated Design Analysis™ software revolutionized electronics reliability and design by enabling designers to predict product failure before a product was ever built, designing in product reliability early in the product development process. This revolutionary tool just got better.

The Evolution

Continuously innovating and evolving, Sherlock 3.0 incorporates enhancements enabling users to manage complex analyses more easily and faster than ever before.

3D FEA Model and 3D Viewer for ICT and Shock and Vibration analysis incorporate fully 3D elements for the PCB, components, and mount points enabling increased simulation accuracy and flexibility for faster analysis. The FEA 3D viewer allows users to visualize 3D models and results interactively and amplify and rotate results to visualize minute changes.

- Multi-core and 64 bit support
- Faster analysis



New Sub-Assembly Analysis allows users to attach one or more circuit card sub-assemblies to the primary circuit card. The software automatically analyzes the main circuit card and all sub-assemblies during a single ICT or shock and vibration analysis.

- Mezzanine cards supported by standoffs
- Edge-connected cards

Call for more information
(301) 474-0607

